This document explains the function of the Camera Payload, its schematic level design, its board level design, and its functional testing

Camera Payload

Camera Payload Design

Revision: 1.1.1

Hendrik

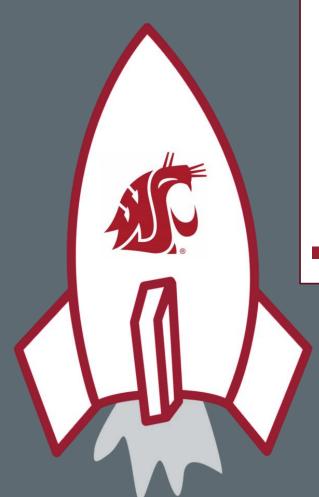


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1 Introduction

This document explains how the Camera Payload will fulfill the following Functions and conform to the following Requirements. This document refers to Camera Payload version 1.1.

1.1 Functions

The Camera Payload is responsible for the following:

- Imaging Earth
- Measure relative ionizing radiation event rate

1.2 Requirements

The system requirements and Camera Payload design requirements can be found on <u>GitHub</u>.





2 Detailed Description

This section refers to the Camera Payload <u>schematic</u>. Page numbers will be listed and may have coordinates listed (number and letter combination found around the frame).

2.1 Functional Block Diagram

The block diagram can be found on page 1 of the schematic.

2.1.1 Ionizing Radiation Sensor

The Ionization Radiation Sensor is responsible for generating digital electronic signals corresponding to high-energy particle hits.

2.1.2 Particle Counter

The Particle Counter is responsible for counting the number of electrical pulses generated by the Ionizing Radiation Sensor.

2.1.3 Cameras

The cameras take pictures of the Earth's surface. There are two cameras on board, one with a wide-angle lens for taking large scale pictures, and another with a telephoto lens, for taking pictures of locations of interest, such as Pullman.

Data from the Cameras will be received and stored by the <u>C&DH</u> subsystem.

2.1.4 Temperature Monitoring

The temperature monitoring is carried out by an ADC connected to the <u>C&DH</u> subsystem. The temperature of various components and at various points on the board are periodically measured and recorded.

2.2 Schematic

2.2.1 Power Roils

Page 2 of the schematic shows the various power rails used by the camera payload.

2.2.2 Isolated Grounds

The 4 isolated grounds can be found on page 4 of the schematic. Power ground (PGND) is connected to the backplane and to the power devices (5V Regulation). All other grounds are shorted to PGND through a 0Ω resistor rated up to 2A. The expected current is less than 50mA. Digital ground (DGND) is connected to the digital components on the board, including the counter, GPIO expander, and cameras. Analog ground (AGND) is connected to the analog components on the board, including the amplifiers and ADC. Chassis ground (CHASSIS) is connected to the mechanical features of the satellite, including the bolt holes and card rails.





2.2.3 5V Regulation

The 51′ regulation can be found on page 3 of the schematic and contains two stages. The first is a switching mode boost converter¹, chosen for its high efficiency. The voltage feedback is set through a voltage divider such that the output is 5.51′. The second stage is a 51′ LDO regulator², chosen for its high PSRR, which regulates the SMPS output down to 5.01′ and attenuates ripple or noise introduced by the switching.

2.2.4 Temperature Monitoring

The temperature monitoring ADC³ can be found on page 3 of the schematic. The ADC is an I²C device which lives on *BUS_I2C1* (address 0x22), and relays it's data to the IHU. There are 8 single-ended inputs, all of which read thermistors from various locations on the board.

2.2.5 Analog Voltage Reference and Supply

The camera payload has an analog voltage supply (Page 3, D3) fed by power rail *PR3.3-10* and filtered by a ferrite bead and capacitors. This powers the ADC and the reference voltage buffer. Precision on this rail is not required, as the ADC produces its own 2.5*V* precision voltage reference. This voltage reference is fed through a unity gain buffer⁴ and used to power the thermistors.

2.2.6 Cameras

The Cameras⁵ can be found on page 4 of the schematic. There are two cameras. The first has a wide-angle lens (140° FOV, capable of seeing the whole earth) for taking large-scale photos of the earth, and the second has a telephoto lens (21° FOV, ~70x70m square per pixel), for taking images of locations of interest, such as Pullman or Area 51. Each camera uses the I²C bus BUS_I2C1 (address 0x20) for receiving commands, and BUS_SPI for transferring data. The camera CS pins are connected to GPIO-0 and GPIO-1 for the telephoto and wide-angle lenses respectively. The cameras are operated by the C&DH⁶ subsystem.

2.2.7 Ionizing Radiation Sensor

The ionizing radiation sensor⁷ can be found on page 4 (C1) of the schematic. The sensor itself is a PIN diode with black epoxy encasement such that its peak sensitivity is particles with energies 2keV - 25keV, which correspond to gamma radiation. The amplifiers are designed to amplify the signal from the photodiode so that the counter can read them. The exact design is a two stage amplifier consisting of a charge amplifier and a differentiator taken directly from

⁷ CIS PN: <u>66-0004</u>





¹ CIS PN: 60-0007

² CIS PN: <u>60-0012</u>

³ CIS PN: <u>27-0003</u>

⁴ CIS PN: 08-0002

⁵ CIS PN: 66-0005

^{6 &}lt;u>C&DH</u>

the white poper⁸ for the device, with a comparator added to the output to square up the output signal.

2.2.8 Particle Counter

The particle counter is a 12-bit binary counter⁹ which counts the pulses from the Ionizing Radiation Sensor. The data is read by an I²C GPIO expander¹⁰ operated by the IHU on *BUS_I2CI*. The same GPIO expander can be used to reset the counter.

2.3 Board

The board shall be double layered with 1 oz copper and ENIG finish. The board shall also conform to the dimensions specified by the <u>CougSat Module Standard</u>.

2.3.1 Layout Constraints

Unless specified in the following subsections, all signals shall us the default parameters below. Signals in the following subsections do not include their sense signals unless otherwise specified. Trace width can be broken if the trace needs to bottleneck down to a pin; the bottleneck shall be minimized.

Trace width: 0.16mm

Vias: $\emptyset 0.3mm$, unlimited count

Separation: 0.16mm Length: unlimited

Devices with specific placement and routing considerations are called out on the schematic, see "CAD Note:"

2.3.1.1 Camera Power Rails - 3.3V-[11,12], PGND

PGND Applies between the cameras and the backplane connector

Trace width: 0.3mm





⁸ Photodiode white paper

⁹ CIS PN: <u>28-0004</u>

3 Testing

All tests shall be performed at room temperature and not under vacuum unless otherwise specified. If any modifications are performed, take note. Include enough information to understand circuit behavior and for others to replicate the results. Include any software written to execute the test and link it in the test notes section. Save all software, waveforms, etc. in a subfolder of the board's test folder for each test¹¹.

- Waveforms shall be captured whenever appropriate
- Have the event take fill the screen (for fast events, zoom in; for slow events, zoom out)
- Label each channel accurately
- Only have bandwidth limiting if necessary for the test (this applies to the oscilloscope and probe settings)
- If ringing or overshoot occurs, use a ground spring or differential probe

Results Location: https://github.com/CougsInSpace/CougSat1- Hardware/tree/master/CougSat1-Payload/Testing/CameraBoard1.1

Common test instructions can be found on the wiki.

3.1 Before First Power-On Check

Configuration:

This test shall be executed before any power is applied to the board.

3.1.1 Test Instructions

Measure the resistance of various points in reference to *PGND* located at the backplane. When measuring in-circuit resistances, flip the probes and take the lower value.

3.1.2 Test Data

Node	Resistance	Node	Resistance
3.3V-10		5.0V	
3.3V-11		AVDD	
3.3V-12		AVREF-0	
BOOST_OUT			

3.1.3 Test Notes

Delete me if no notes are required.

3.2 5V Regulator

Configuration:

¹¹ For test 3.1, place files in subfolder "3.1" and so on





Result:

This test evaluates the circuit described in 5V Regulation.

3.2.1 Output Voltage

3.2.1.1 Test Instructions

Apply 3.3V to 3.3V-10 at the backplane before executing this test. Measure the voltage of the 5.0V regulator at no load and at a 30mA resistive load.

Note: Measure the DC Component of the voltage with $PLC^{12} > 100$.

3.2.1.2 Test Data

Measure	Measure the DC voltage at the output of the 5.0V regulator					
Load Voltage		Passing Criteria	Pass / Fail			
No Load		4.900V < V < 5.100V				
30 <i>mA</i>		4.900V < V < 5.100V				

3.2.1.3 Test Notes

Delete me if no notes are required.

3.2.2 Output Ripple and Noise

3.2.2.1 Test Instructions

Apply 3.3V to 3.3V-10 at the backplane before executing this test. Measure the ripple of the 5.0V regulator at no load and at a 30mA resistive load.

Note: Measure the RMS value of the AC component with f > 3Hz.

3.2.2.2 Test Data

Measure the RMS ripple at the output of the 5.0V regulator						
Load Ripple Passing Criteria Pass						
No Load		$ V_{ripple} < 25mV$				
30mA		$ V_{ripple} < 25mV$				

3.2.2.3 Test Notes

Delete me if no notes are required.

3.3 Analog Voltage Reference and Supply

Configuration:

Result:

This test evaluates the circuits described in Analog Voltage Reference and Supply.

¹² Power Line Cycles: DMM setting to average during 100 cycles of the 60Hz wall outlet





3.3.1 Analog Voltage Supply

3.3.1.1 Test Instructions

Apply 3.3V to 3.3V-10 at the backplane before executing this test.

Measure the noise and ripple of AVDD under a 10mA load.

Note: Measure DC voltage with PLC > 100, measure the RMS AC component with f > 3Hz.

3.3.1.2 Test Data

Measure the noise and ripple of AVDD under a 10mA load						
Measured	Voltage	Passing Criteria	Pass / Fail			
DC Voltage		3.2V < V < 3.4V				
Ripple		$\left V_{ripple}\right < 17mV$				

3.3.1.3 Test Notes

Delete me if no notes are required.

3.3.2 Analog Voltage Reference

3.3.2.1 Test Instructions

Apply 3.3V to 3.3V-10 at the backplane before executing this test.

Measure the DC voltage, noise, and ripple of AVREF-0.

Note: Measure DC voltage with PLC > 100, measure the RMS AC component with f > 3Hz.

3.3.2.2 Test Data

Measure the noise and ripple of AVREF-0					
Measured	Voltage	Passing Criteria	Pass / Fail		
DC Voltage		2.4975V < V < 2.5025V			
Ripple		$\left V_{ripple}\right < 3.3mV$			

3.3.2.3 Test Notes

Delete me if no notes are required.

3.4 Temperature Monitoring

Configuration:

Result:

This test evaluates the circuit described in Temperature Monitoring.

3.4.1 Test Instructions

Apply 3.3V to 3.3V-10 before executing this test. Connect the ADC to a microcontroller on BUS_12C1. Compare the voltage measured by the





microcontroller and the voltage measured by a thermometer at the following temperature sensors:

Camera 0

Top Left

Note: $Error = |T_{\mu C} - T_{thermometer}|$

3.4.2 Test Data

Compare the temperatures read by a μ Controller and a Thermometer						
Location		Thermometer Temperature	Error	Passing Criteria	Pass / Fail	
Camera 0				<i>Error</i> < 2° <i>C</i>		
Top Left				Error < 2°C		

3.4.3 Test Notes

Delete me if no notes are required.

3.5 Cameras

Configuration:

Result:

This test evaluates the circuit described in Cameras.

3.5.1 Test Instructions

Apply 3.3V to both 3.3V-11 and 3.3V-12 before executing this test.

Connect the cameras to a microcontroller on *BUS_I2C1* and *BUS_SPI*. Take a photo with each. Include the photograph.

3.5.2 Test Data

Camera	Photo	Passing	Pass /
		Criteria	Fail
Camera 0		Signal Integrity	
Camera 1		Signal Integrity	

3.5.3 Test Notes

Delete me if no notes are required.

3.6 Particle Counter

Configuration:

Result:

This test evaluates the circuits described in Ionizing Radiation Sensor and Particle Counter.





3.6.1 Test Instructions

Apply 3.3V to 3.3V-10 before executing this test. Read the value on the binary counter continuously while bringing a non-irradiated sample, a banana, and a known gamma source close to the sensor.

3.6.2 Test Data

Bring various samples close to the sensor, observe the value on the counter.					
Sample	Passing Criteria	Pass / Fail			
Non-Irradiated Sample	Counter value increases very little				
Banana	Counter value increases some				
Known Gamma Source	Counter value increases a lot				

3.6.3 Test Notes

Delete me if no notes are required.



